

# N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 122 A, 3.9 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 3.9 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 19 A
- Max r<sub>DS(on)</sub> = 5.5 mΩ at V<sub>GS</sub> = 8 V, I<sub>D</sub> = 15.5 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

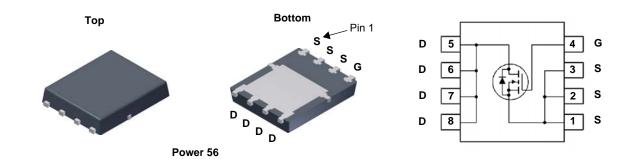


# **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed and body diode reverse recovery performance.

## **Applications**

- OringFET / Load Switching
- DC-DC Conversion



# MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			80	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C		122		
	-Continuous	ous $T_{\rm C} = 100 ^{\circ}{\rm C}$		78	•	
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	19	Α	
	-Pulsed		(Note 4)	556		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	252	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		104	14/	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/W

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86300	FDMS86300	Power 56	13 "	12 mm	3000 units

FDMS86300
N-Channel
PowerTrench
<sup>®</sup> MOSFET

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	80			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		39		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2.5	3.4	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-11		mV/°C
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A		3.2	3.9	
		V <sub>GS</sub> = 8 V, I <sub>D</sub> = 15.5 A		3.8	5.5	mΩ
- ( - )		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A, T <sub>J</sub> = 125 °C		5.0	5.8	
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 19 A		60		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			5325	7082	pF
C <sub>oss</sub>	Output Capacitance	— V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, — f = 1 MHz		957	1272	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			26	63	pF
R <sub>g</sub>	Gate Resistance			1.2		Ω
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			31	50	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 40 V, I <sub>D</sub> = 19 A,		26	43	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		36	58	ns
t <sub>f</sub>	Fall Time			9	18	ns
Q <sub>q</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		72	86	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 8 V V_{DD} = 40 V,$		59	71	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 19 A		28.2		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			14.9		nC
Drain-Sou	rce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.71	1.2	
		$V_{GS} = 0 V, I_S = 19 A$ (Note 2)		0.81	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	1 = 10  A = 100  A = 100  A = 100  A		57	90	ns
Q <sub>rr</sub>	Reverse Recovery Charge	- I <sub>F</sub> = 19 A, di/dt = 100 A/μs		50	80	nC
t <sub>rr</sub>	Reverse Recovery Time	1 = 10.4 di/dt = 200.4/m		48	77	ns
Q <sub>rr</sub>	Reverse Recovery Charge	—I <sub>F</sub> = 19 A, di/dt = 300 A/μs		103	165	nC

Q<sub>rr</sub>

Notes: 1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



Reverse Recovery Charge

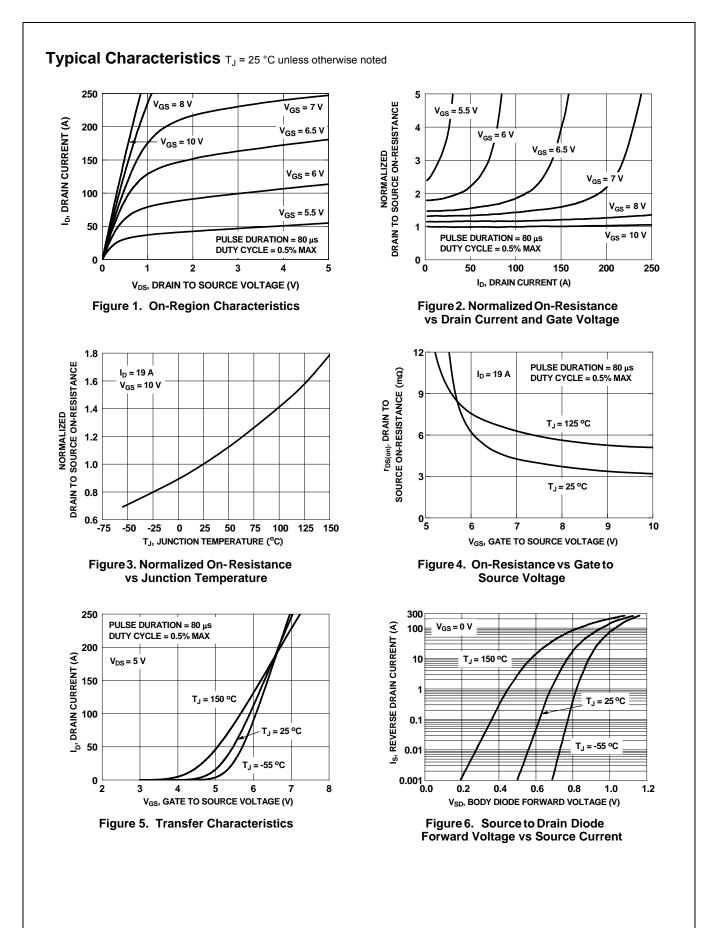
a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

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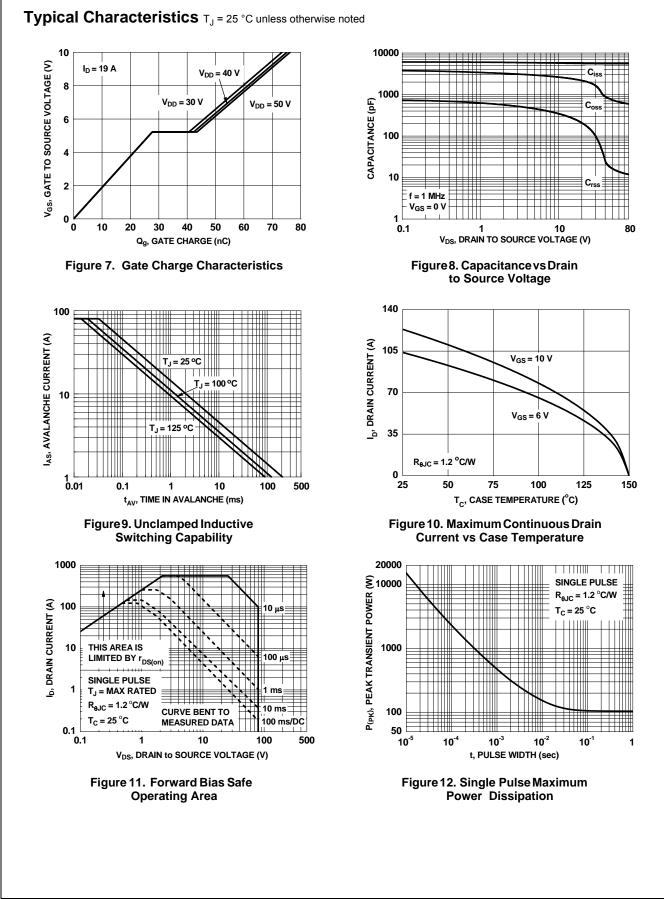
b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

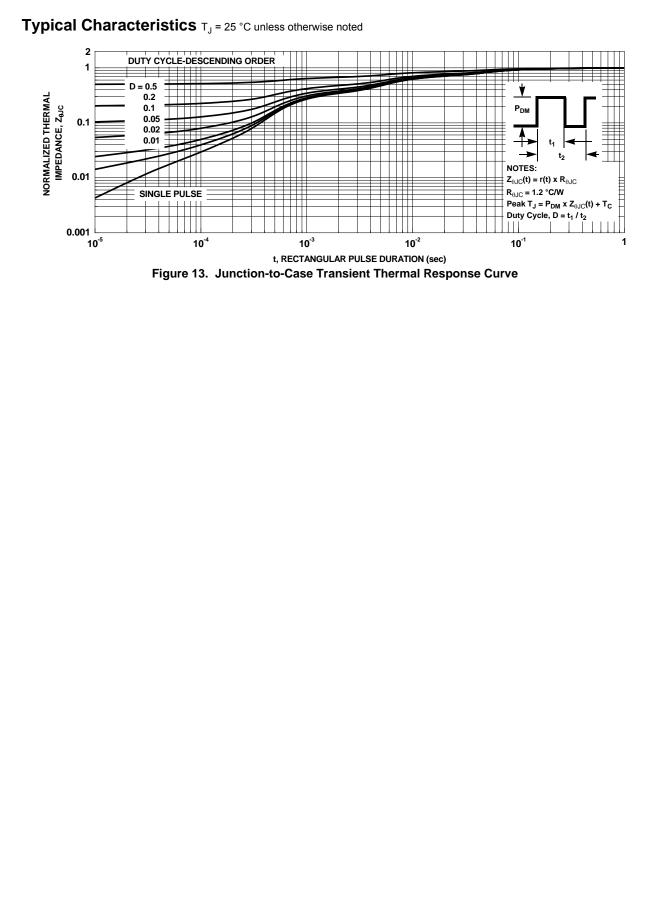
3. E<sub>AS</sub> of 252 mJ is based on starting T<sub>J</sub> = 25 °C, L = 0.3 mH, I<sub>AS</sub> = 41 A, V<sub>DD</sub> = 72 V, V<sub>GS</sub> = 10 V. 4. Pulse Id limited by junction temperature, td ≤ 100  $\mu$ s, please refer to SOA curve for more details.







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FDMS86300 N-Channel PowerTrench<sup>®</sup> MOSFET





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